

SN54LVT16646, SN74LVT16646
3.3-V ABT 16-BIT BUS TRANSCEIVERS AND REGISTERS
WITH 3-STATE OUTPUTS

SCBS149D – JULY 1994 – REVISED MARCH 2004

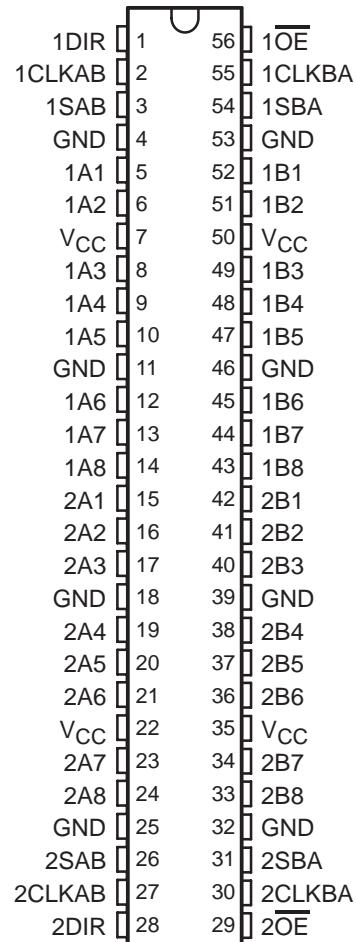
- **Members of the Texas Instruments Widebus™ Family**
- **State-of-the-Art Advanced BiCMOS Technology (ABT) Design for 3.3-V Operation and Low-Static Power Dissipation**
- **Support Mixed-Mode Signal Operation (5-V Input and Output Voltages With 3.3-V V_{CC})**
- **Support Unregulated Battery Operation Down to 2.7 V**
- **Typical V_{OLP} (Output Ground Bounce) <0.8 V at V_{CC} = 3.3 V, T_A = 25°C**
- **Bus-Hold Data Inputs Eliminate the Need for External Pullup Resistors**
- **I_{off} and Power-Up 3-State Support Hot Insertion**
- **Distributed V_{CC} and GND Pin Configuration Minimizes High-Speed Switching Noise**
- **Flowthrough Architecture Optimizes PCB Layout**
- **Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17**
- **ESD Protection Exceeds JESD 22**
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)

description/ordering information

The 'LVT16646 devices are 16-bit bus transceivers and registers designed for low-voltage (3.3-V) V_{CC} operation, but with the capability to provide a TTL interface to a 5-V system environment.

These devices can be used as two 8-bit transceivers or one 16-bit transceiver. Data on the A or B bus is clocked into the registers on the low-to-high transition of the appropriate clock (CLKAB or CLKBA) input. Figure 1 illustrates the four fundamental bus-management functions that can be performed with the 'LVT16646 devices.

SN54LVT16646 . . . WD PACKAGE
SN74LVT16646 . . . DGG OR DL PACKAGE
(TOP VIEW)



ORDERING INFORMATION

T _A	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
-40°C to 85°C	SSOP – DL	Tube	SN74LVT16646DL	LVT16646
		Tape and reel	SN74LVT16646DLR	
	TSSOP – DGG	Tape and reel	SN74LVT16646DGGR	LVT16646
-55°C to 125°C	CFP – WD	Tube	SNJ54LVT16646WD	SNJ54LVT16646WD

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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**TEXAS
INSTRUMENTS**

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description/ordering information (continued)

Output-enable (\overline{OE}) and direction-control (DIR) inputs are provided to control the transceiver functions. In the transceiver mode, data present at the high-impedance port may be stored in either register or in both. The select-control (SAB and SBA) inputs can multiplex stored and real-time (transparent mode) data. The circuitry used for select control eliminates the typical decoding glitch that occurs in a multiplexer during the transition between stored and real-time data. The direction control (DIR) determines which bus receives data when \overline{OE} is low. In the isolation mode (\overline{OE} high), A data may be stored in one register and/or B data may be stored in the other register.

When an output function is disabled, the input function is still enabled and may be used to store and transmit data. Only one of the two buses, A or B, may be driven at a time.

Active bus-hold circuitry holds unused or undriven inputs at a valid logic state. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended.

These devices are fully specified for hot-insertion applications using I_{off} and power-up 3-state. The I_{off} circuitry disables the outputs, preventing damaging current backflow through the devices when they are powered down. The power-up 3-state circuitry places the outputs in the high-impedance state during power up and power down, which prevents driver conflict.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

FUNCTION TABLE

INPUTS						DATA I/Os		OPERATION OR FUNCTION
\overline{OE}	DIR	CLKAB	CLKBA	SAB	SBA	A1 THRU A8	B1 THRU B8	
X	X	↑	X	X	X	Input	Unspecified†	Store A, B unspecified†
X	X	X	↑	X	X	Unspecified†	Input	Store B, A unspecified†
H	X	↑	↑	X	X	Input	Input	Store A and B data
H	X	H or L	H or L	X	X	Input disabled	Input disabled	Isolation, hold storage
L	L	X	X	X	L	Output	Input	Real-time B data to A bus
L	L	X	H or L	X	H	Output	Input	Stored B data to A bus
L	H	X	X	L	X	Input	Output	Real-time A data to B bus
L	H	H or L	X	H	X	Input	Output	Stored A data to B bus

† The data output functions may be enabled or disabled by various signals at \overline{OE} and DIR. Data input functions always are enabled; i.e., data at the bus pins are stored on every low-to-high transition of the clock inputs.

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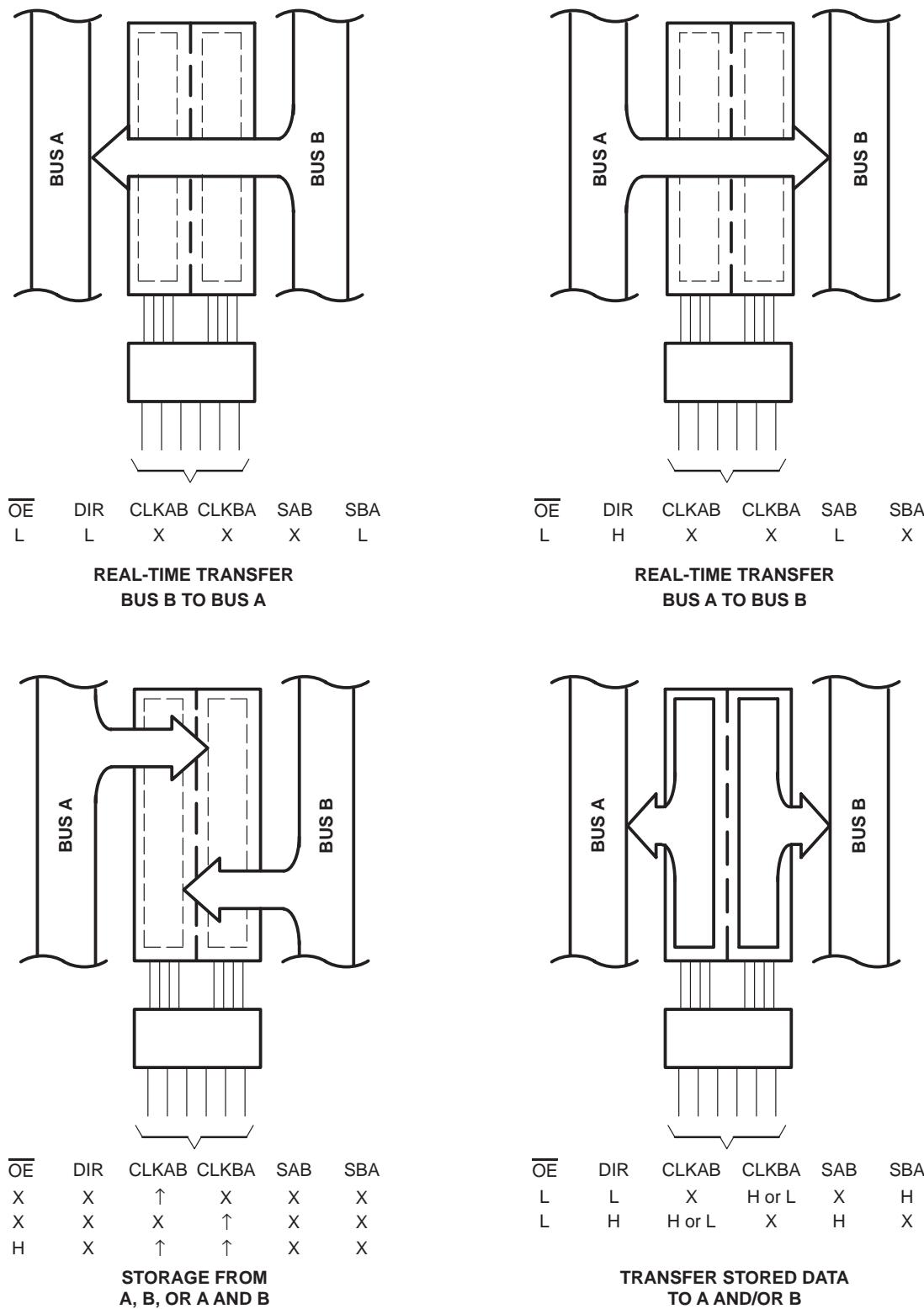


Figure 1. Bus-Management Functions

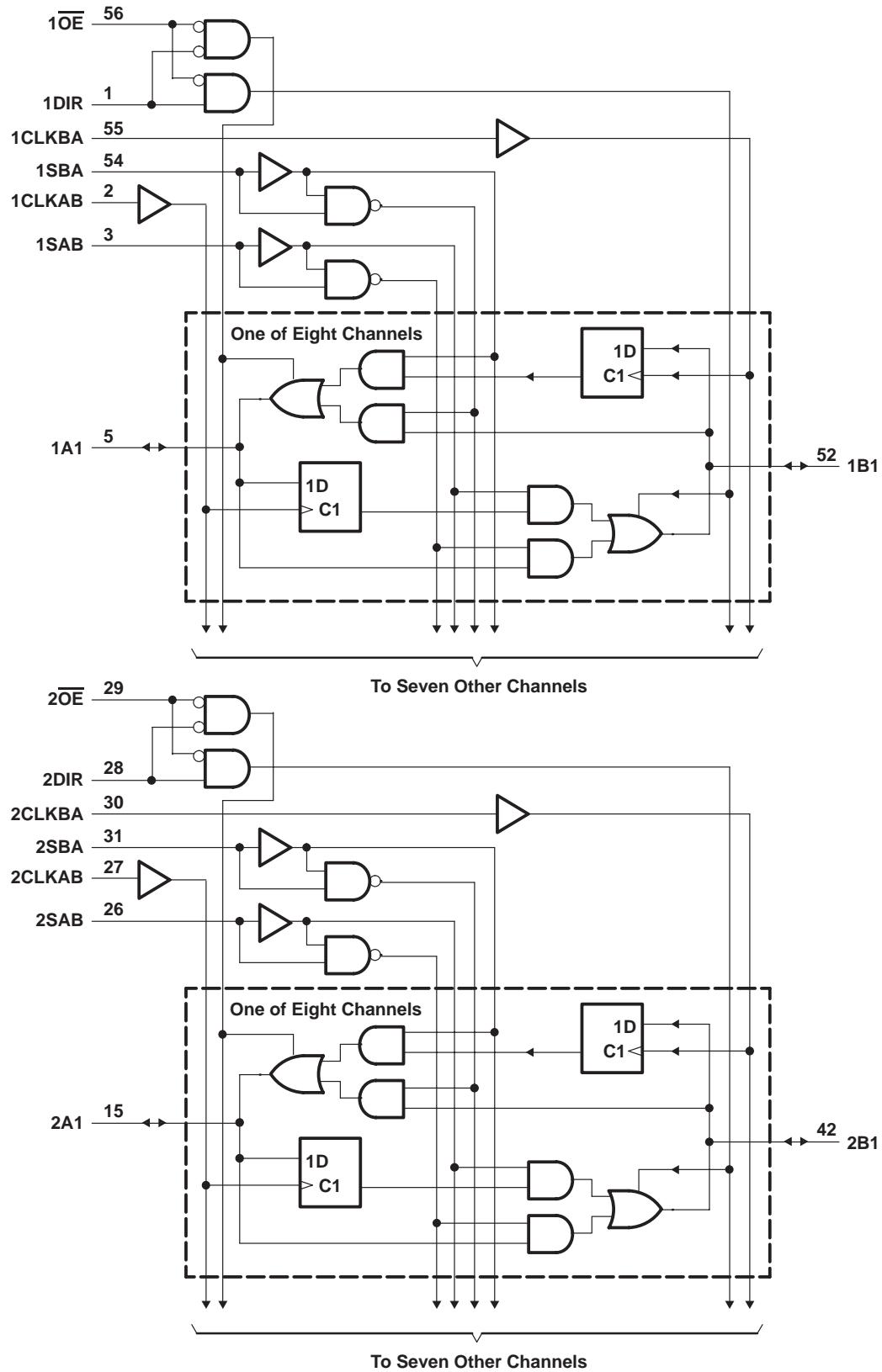
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logic diagram (positive logic)



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
 2. This current flows only when the output is in the high state and $V_O > V_{CC}$.
 3. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 4)

		SN54LVT16646		SN74LVT16646		UNIT
		MIN	MAX	MIN	MAX	
V _{CC}	Supply voltage	2.7	3.6	2.7	3.6	V
V _{IH}	High-level input voltage	2		2		V
V _{IL}	Low-level input voltage		0.8		0.8	V
V _I	Input voltage		5.5		5.5	V
I _{OH}	High-level output current		-24		-32	mA
I _{OL}	Low-level output current		48		64	mA
Δt/Δv	Input transition rise or fall rate	Outputs enabled		10	10	ns/V
T _A	Operating free-air temperature	-55	125	-40	85	°C

NOTE 4: All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	SN54LVT16646			SN74LVT16646			UNIT
		MIN	TYP†	MAX	MIN	TYP†	MAX	
V_{IK}	$V_{CC} = 2.7 \text{ V}$, $I_I = -18 \text{ mA}$			-1.2			-1.2	V
V_{OH}	$V_{CC} = \text{MIN to MAX}^‡$, $I_{OH} = -100 \mu\text{A}$	$V_{CC} - 0.2$			$V_{CC} - 0.2$			V
	$V_{CC} = 2.7 \text{ V}$, $I_{OH} = -8 \text{ mA}$	2.4			2.4			
	$V_{CC} = 3 \text{ V}$	$I_{OH} = -24 \text{ mA}$	2				2	
		$I_{OH} = -32 \text{ mA}$						
V_{OL}	$V_{CC} = 2.7 \text{ V}$	$I_{OL} = 100 \mu\text{A}$		0.2			0.2	V
		$I_{OL} = 24 \text{ mA}$		0.5			0.5	
	$V_{CC} = 3 \text{ V}$	$I_{OL} = 16 \text{ mA}$		0.4			0.4	
		$I_{OL} = 32 \text{ mA}$		0.5			0.5	
		$I_{OL} = 48 \text{ mA}$		0.55				
		$I_{OL} = 64 \text{ mA}$					0.55	
I_I	$V_{CC} = 3.6 \text{ V}$, $V_I = V_{CC} \text{ or GND}$	Control inputs		±1			±1	μA
	$V_{CC} = 0 \text{ or MAX}^‡$, $V_I = 5.5 \text{ V}$			10			10	
	$V_{CC} = 3.6 \text{ V}$	$V_I = 5.5 \text{ V}$		20			20	
		$V_I = V_{CC}$		5			5	
		$V_I = 0$		-10			-10	
I_{off}	$V_{CC} = 0$, $V_I \text{ or } V_O = 0 \text{ to } 4.5 \text{ V}$						±100	μA
$I_{I(\text{hold})}$	$V_{CC} = 3 \text{ V}$	$V_I = 0.8 \text{ V}$	A or B ports	75			75	μA
		$V_I = 2 \text{ V}$		-75			-75	
I_{OZH}	$V_{CC} = 3.6 \text{ V}$, $V_O = 3 \text{ V}$				1		1	μA
I_{OZL}	$V_{CC} = 3.6 \text{ V}$, $V_O = 0.5 \text{ V}$				-1		-1	μA
I_{CC}	$V_{CC} = 3.6 \text{ V}$, $V_I = V_{CC} \text{ or GND}$	$I_O = 0$	Outputs high		0.12		0.12	mA
			Outputs low		5		5	
			Outputs disabled		0.12		0.12	
$\Delta I_{CC}^¶$	$V_{CC} = 3 \text{ V to } 3.6 \text{ V}$, One input at $V_{CC} - 0.6 \text{ V}$, Other inputs at V_{CC} or GND				0.2		0.2	mA
C_I	$V_I = 3 \text{ V or } 0$			3.5			3.5	pF
C_{io}	$V_O = 3 \text{ V or } 0$			12			12	pF

† All typical values are at $V_{CC} = 3.3 \text{ V}$, $T_A = 25^\circ\text{C}$.

‡ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

§ Unused pins at V_{CC} or GND¶ This is the increase in supply current for each input that is at the specified TTL voltage level, rather than V_{CC} or GND.

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timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figure 2)

			SN54LVT16646		SN74LVT16646		UNIT	
			V _{CC} = 3.3 V ± 0.3 V		V _{CC} = 2.7 V			
			MIN	MAX	MIN	MAX		
f _{clock}	Clock frequency		150		150		150	MHz
t _W	Pulse duration, CLK high or low		3.3		3.3		3.3	ns
t _{SU}	Setup time, A or B before CLKAB↑ or CLKBA↑	Data high	1.3		1.4		1.3	1.4
		Data low	2.4		3		2.4	3
t _H	Hold time, A or B after CLKAB↑ or CLKBA↑	Data high	0.5		0		0.5	0
		Data low	0.6		0.5		0.5	0.5

switching characteristics over recommended operating free-air temperature range, C_L = 50 pF (unless otherwise noted) (see Figure 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN54LVT16646		SN74LVT16646		UNIT	
			V _{CC} = 3.3 V ± 0.3 V		V _{CC} = 2.7 V			
			MIN	MAX	MIN	MAX		
f _{max}			150		150		MHz	
t _{PLH}	CLKBA or CLKAB	A or B	1.8	6	6.9	1.8 3.8 5.7	6.7	
			2.1	5.9	6.6	2.1 3.9 5.7	6.5	
t _{PLH}	A or B	B or A	1.3	4.9	5.6	1.3 3 4.7	5.4	
			1	4.8	5.8	1 3.1 4.7	5.6	
t _{PLH}	SBA or SAB [‡]	A or B	1.4	6.4	7.4	1.4 4 6.2	7.2	
			1.4	6.4	7.4	1.4 4.3 6.2	7.2	
t _{PZH}	\overline{OE}	A or B	1	5.7	7.4	1 3 5.4	6.4	
			1	6.5	7.5	1 3.1 5.6	6.5	
t _{PHZ}	\overline{OE}	A or B	2.3	6.7	7.1	2.3 4.6 6.5	6.9	
			2.2	6	6.5	2.2 4.5 5.8	5.9	
t _{PZH}	DIR	A or B	1	5.9	7.7	1 3.3 5.7	6.7	
			1.2	5.9	7.3	1.2 3.5 5.8	6.7	
t _{PHZ}	DIR	A or B	1.7	7.3	8.5	1.7 4.7 7.2	8.3	
			1.5	7.8	7.4	1.5 4.9 6.6	7.2	

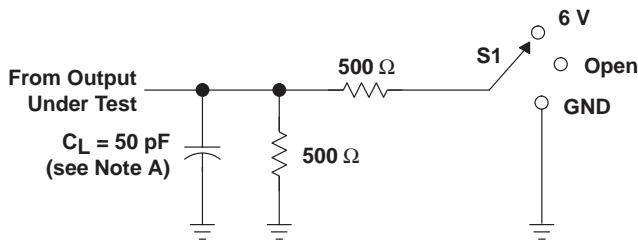
[†]All typical values are at V_{CC} = 3.3 V, T_A = 25°C.

[‡]These parameters are measured with the internal output state of the storage register opposite to that of the bus input.

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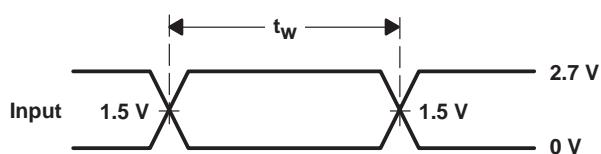
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PARAMETER MEASUREMENT INFORMATION



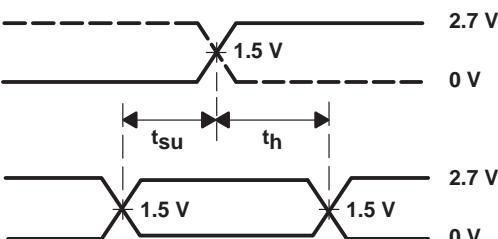
TEST	S1
t_{PLH}/t_{PHL}	Open
t_{PLZ}/t_{PZL}	6 V
t_{PHZ}/t_{PZH}	GND

LOAD CIRCUIT FOR OUTPUTS

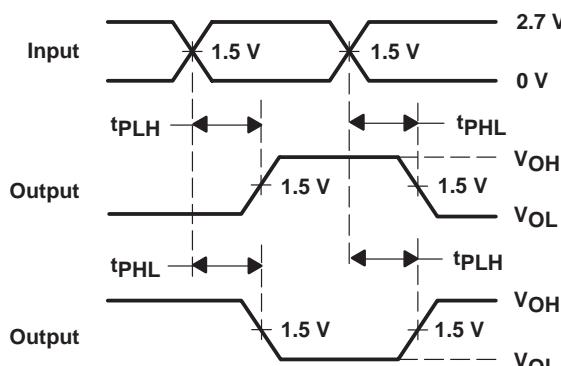


**VOLTAGE WAVEFORMS
PULSE DURATION**

Timing Input



**VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES**

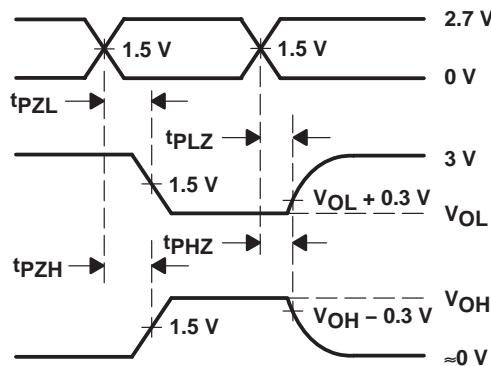


**VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES
INVERTING AND NONINVERTING OUTPUTS**

Output Control

Output Waveform 1
S1 at 6 V
(see Note B)

Output Waveform 2
S1 at GND
(see Note B)



**VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES
LOW- AND HIGH-LEVEL ENABLING**

NOTES: A. C_L includes probe and jig capacitance.

B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.

C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $t_r \leq 2.5$ ns, $t_f \leq 2.5$ ns.

D. The outputs are measured one at a time, with one transition per measurement.

E. All parameters and waveforms are not applicable to all devices.

Figure 2. Load Circuit and Voltage Waveforms

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN74LVT16646DL	ACTIVE	SSOP	DL	56	20	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LVT16646	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

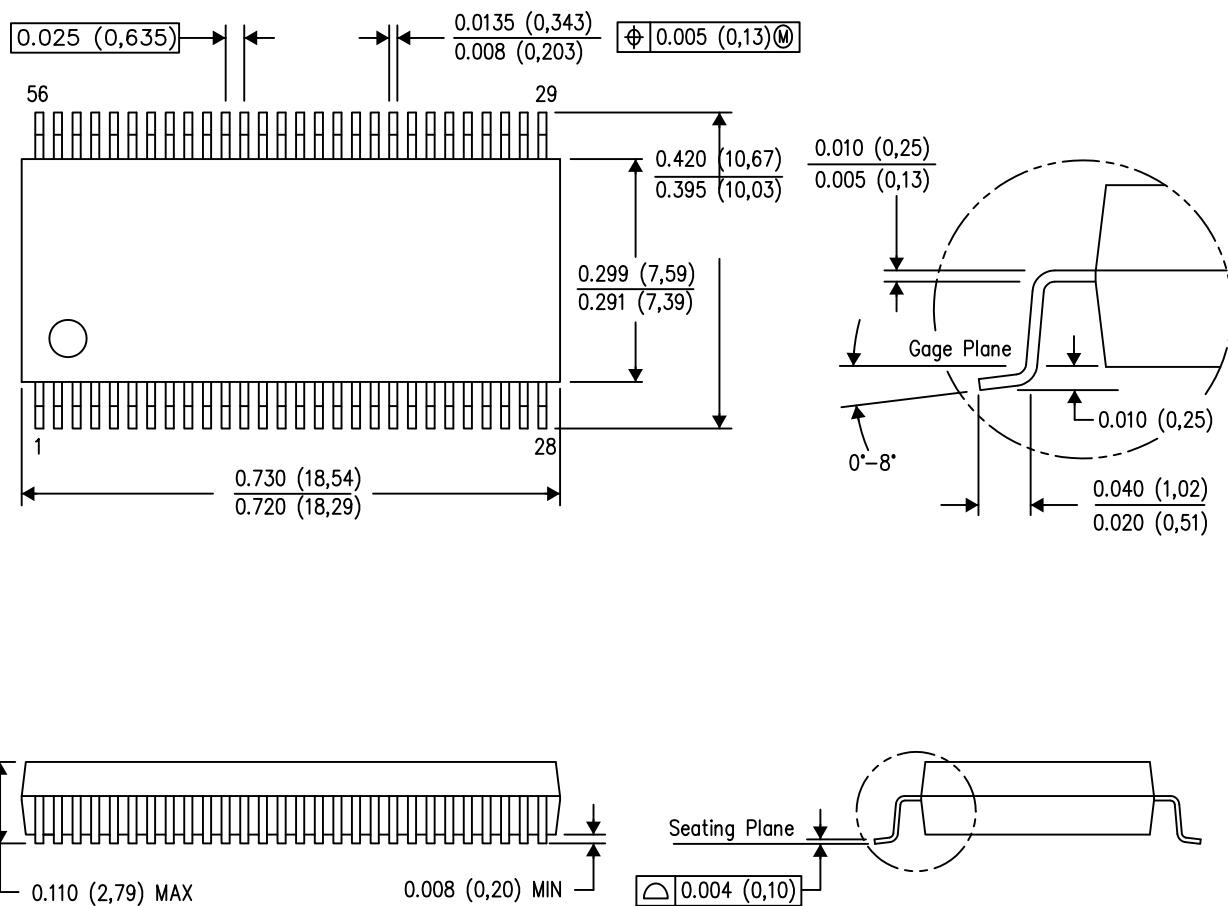
(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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DL (R-PDSO-G56)

PLASTIC SMALL-OUTLINE PACKAGE



4040048-4/F 05/13

NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC M0-118

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